

# **P-Channel Power MOSFET**

-20V, -6.5A, 26mΩ

#### **FEATURES**

- Fast switching
- Suitable for -1.8V Gate Drive Applications
- Pb-free plating
- RoHS compliant
- Halogen-free mold compound

KEY PERFORMANCE PARAMETERS				
PARAMETER		VALUE	UNIT	
$V_{DS}$		-20	V	
Ι <sub>D</sub>		-6.5	Α	
R <sub>DS(on)</sub> (max)	$V_{GS} = -4.5V$	26		
	$V_{GS} = -2.5V$	32	mΩ	
	V <sub>GS</sub> = -1.8V	40		
$\mathbf{Q}_{g}$		19.5	nC	





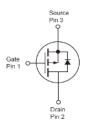


#### **APPLICATION**

- Battery Pack
- Portable Devices







#### Note:

- 1. MSL 1 (Moisture Sensitivity Level) for SOT-26 per J-STD-020
- 2. MSL 3 (Moisture Sensitivity Level) for SOT-23 per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	-20	V
Gate-Source Voltage		V <sub>GS</sub>	±10	V
Continuous Drain Current	$T_C = 25^{\circ}C$		-6.5	۸
	$T_C = 100$ °C	I <sub>D</sub>	-4.1	A
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	-26	А
Total Power Dissipation	T <sub>C</sub> = 25°C	P <sub>DTOT</sub>	1.56	W
Operating Junction Temperature		T <sub>J</sub>	150	ōC
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	- 55 to +150	°C

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	TINU	
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	80	°C/W	

**Notes:**  $R_{\Theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances.  $R_{\Theta JC}$  is guaranteed by design while  $R_{\Theta CA}$  is determined by the user's board design.  $R_{\Theta JA}$  is shown for single device operation on FR-4 PCB in still air.



<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static (Note 2)						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	BV <sub>DSS</sub>	-20			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	$V_{GS(TH)}$	-0.3	-0.6	-1.0	V
Gate Body Leakage	$V_{GS} = \pm 10V, V_{DS} = 0V$	I <sub>GSS</sub>			±100	nA
Zero Gate Voltage Drain Current	$V_{DS} = -20V, V_{GS} = 0V$				-1	μΑ
	$V_{DS} = -16V, T_{J} = 125^{\circ}C$	I <sub>DSS</sub>			-10	
Drain-Source On-State Resistance	$V_{GS} = -4.5V, I_D = -5A$			21	26	mΩ
	$V_{GS} = -2.5V, I_D = -4A$	R <sub>DS(on)</sub>		26	32	
	$V_{GS} = -1.8V, I_D = -3A$			32	40	
Forward Transconductance	$V_{DS} = -10V, I_{S} = -5A$	$g_{fs}$		15		S
Dynamic (Note 3)						
Total Gate Charge	$V_{DS} = -10V, I_{D} = -5A,$ $V_{GS} = -4.5V$	$Q_g$		19.5		nC
Gate-Source Charge		$Q_gs$		2		
Gate-Drain Charge		$Q_gd$		3.6		
Input Capacitance	V 45V V 0V	C <sub>iss</sub>		1670		
Output Capacitance	$V_{DS} = -15V, V_{GS} = 0V,$ F = 1.0MHz	C <sub>oss</sub>		220		рF
Reverse Transfer Capacitance	F = 1.0WHZ	$C_{rss}$		120		
Switching						
Turn-On Delay Time		t <sub>d(on)</sub>		10.4		
Turn-On Rise Time	$V_{DD} = -10V, I_{D} = -1A,$ $V_{GS} = -4.5V,$ $R_{GEN} = 25\Omega$	t <sub>r</sub>		37.5		]
Turn-Off Delay Time		t <sub>d(off)</sub>		89.1		ns
Turn-Off Fall Time	- TIGEN -2312	t <sub>f</sub>		24.6		
Source-Drain Diode						
Forward Voltage	$V_{GS} = 0V, I_{S} = -1A$	$V_{SD}$			-1	V
Continuous Forward Current	Integral reverse diode	I <sub>S</sub>			-6.5	Α
Pulse Forward Current	in the MOSFET	I <sub>SM</sub>			-26	Α

#### Notes:

- 1. Pulse width limited by safe operating area
- 2. Pulse test: PW  $\leq$  300 $\mu$ s, duty cycle  $\leq$  2%
- Switching time is essentially independent of operating temperature.





### **ORDERING INFORMATION**

ORDERING CODE	PACKAGE	PACKING
TSM260P02CX RFG	SOT-23	3,000pcs / 7" Reel
TSM260P02CX6 RFG	SOT-26	3,000pcs / 7" Reel

#### Note:

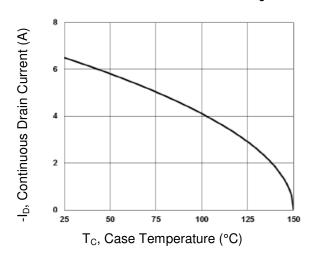
- 1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- 2. Halogen-free according to IEC 61249-2-21 definition



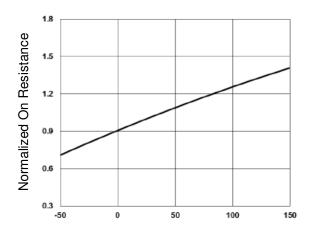
### **CHARACTERISTICS CURVES**

(T<sub>C</sub> = 25°C unless otherwise noted)

### Continuous Drain Current vs. Tc

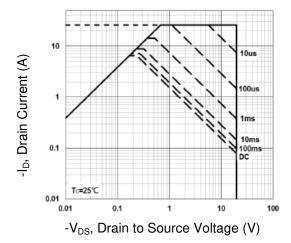


### **On-Resistance vs. Junction Temperature**

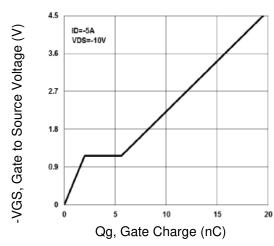


T<sub>J</sub>, Junction Temperature (°C)

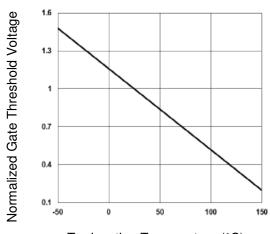
#### **Maximum Safe Operating Area**



### **Gate Charge**

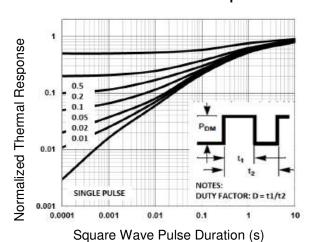


### Threshold Voltage vs. Junction Temperature



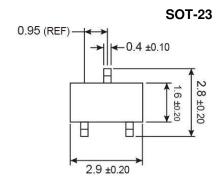
T<sub>J</sub>, Junction Temperature (°C)

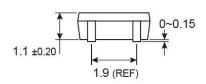
#### **Normalized Thermal Transient Impedance Curve**

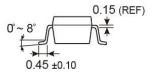




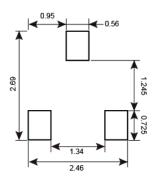
# PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)







# SUGGESTED PAD LAYOUT (Unit: Millimeters)



# **MARKING DIAGRAM**



26 = Device Code

Y = Year Code

**M** = Month Code for Halogen Free Product

O =Jan P =Feb Q =Mar R =Apr S =May T =Jun U =Jul V =Aug

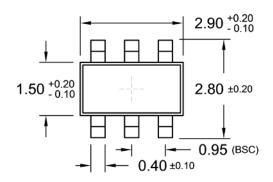
W = Sep X = Oct Y = Nov Z = Dec

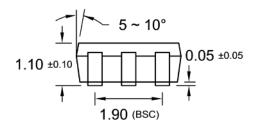
L = Lot Code

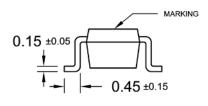


### PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

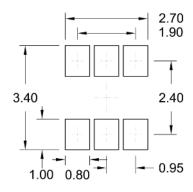
### **SOT-26**



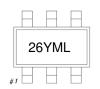




### SUGGESTED PAD LAYOUT (Unit: Millimeters)



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**L** = Lot Code  $(1 \sim 9, A \sim Z)$ 





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